STA508

40V 4.5A QUAD POWER HALF BRIDGE

1 FEATURES

- MULTIPOWER BCD TECHNOLOGY
- MINIMUM INPUT OUTPUT PULSE WIDTH DISTORTION
- 200mΩ R_{dsON} COMPLEMENTARY DMOS OUTPUT STAGE
- CMOS COMPATIBLE LOGIC INPUTS
- THERMAL PROTECTION
- THERMAL WARNING OUTPUT
- UNDER VOLTAGE PROTECTION

Figure 1. Package



PowerSO36

Table 1. Order Codes

Part Number	Package
STA508	PowerSO36

2 DESCRIPTION

STA508 is a monolithic quad half bridge stage in Multipower BCD Technology. The device can be used as dual bridge or reconfigured, by connecting CONFIG pin to Vdd pin, as single bridge with double current capability, and as half bridge (Binary mode) with half current capability.

The device is particularly designed to make the output stage of a stereo All-Digital High Efficiency (DDX™) amplifier capable to deliver 80 + 80W @ THD = 10% at V_{cc} 35V output power on 8Ω load.

In single BTL configuration is also capable to deliver a peak of 160W @THD = 10% at V_{CC} = 35V on 4Ω load. The input pins have threshold proportional to V_L pin voltage.

Figure 2. Block Diagram

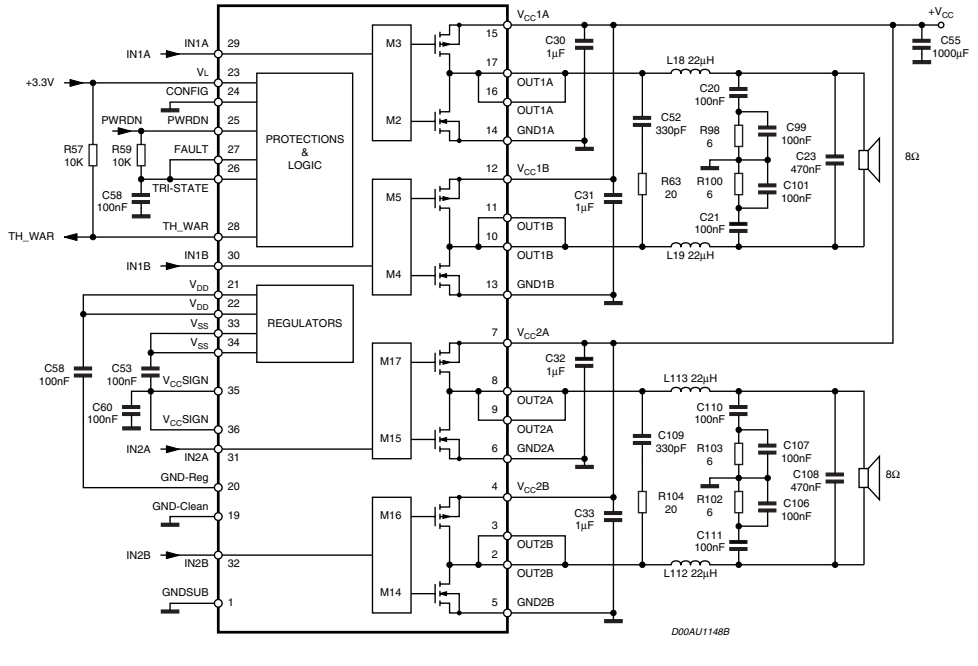


Table 2. Pin Description

N°	Pin	Description
1	GND-SUB	Substrate Ground
2 ; 3	OUT2B	Output Half Bridge 2B
4	V_{CC} 2B	Positive Supply
5	GND2B	Negative Supply
6	GND2A	Negative Supply
7	V_{CC} 2A	Positive Supply
8 ; 9	OUT2A	Output Half Bridge 2A
10 ; 11	OUT1B	Output Half Bridge 1B
12	V_{CC}1B	Positive Supply
13	GND1B	Negative Supply
14	GND1A	Negative Supply
15	V_{CC}1A	Positive Supply
16 ; 17	OUT1A	Output Half Bridge 1A
18	NC	Not Connected
19	GND-clean	Logical Ground
20	GND-Reg	Ground for Regulator V_{dd}
21 ; 22	V_{dd}	5V Regulator Referred to Ground
23	V_L	High Logical State Setting Voltage
24	CONFIG	Configuration pin
25	PWRDN	Stand-by pin
26	TRI-STATE	Hi-Z pin
27	FAULT	Fault pin Advisor
28	TH-WAR	Thermal Warning Advisor
29	IN1A	Input of Half Bridge 1A
30	IN1B	Input of Half Bridge 1B
31	IN2A	Input of Half Bridge 2A
32	IN2B	Input of Half Bridge 2B
33 ; 34	V_{SS}	5V Regulator Referred to +V_{CC}
35 ; 36	V_{CC} Sign	Signal Positive Supply

Table 3. FUNCTIONAL PIN STATUS

PIN NAME	Logical value	IC -STATUS
FAULT	0	Fault detected (Short circuit, or Thermal ..)
FAULT (*)	1	Normal Operation
TRI-STATE	0	All powers in Hi-Z state
TRI-STATE	1	Normal operation
PWRDN	0	Low absorpion
PWRDN	1	Normal operation
THWAR	0	Temperature of the IC =130°C
THWAR(*)	1	Normal operation
CONFIG	0	Normal Operation
CONFIG(**)	1	OUT1A = OUT1B ; OUT2A=OUT2B (IF IN1A = IN1B; IN2A = IN2B)

(*) : The pin is open collector. To have the high logic value, it needs to be pulled up by a resistor.
(**): To put CONFIG = 1 means connect Pin 24 (CONFIG) to Pins 21, 22 (Vdd)

Figure 3. PIN CONNECTION

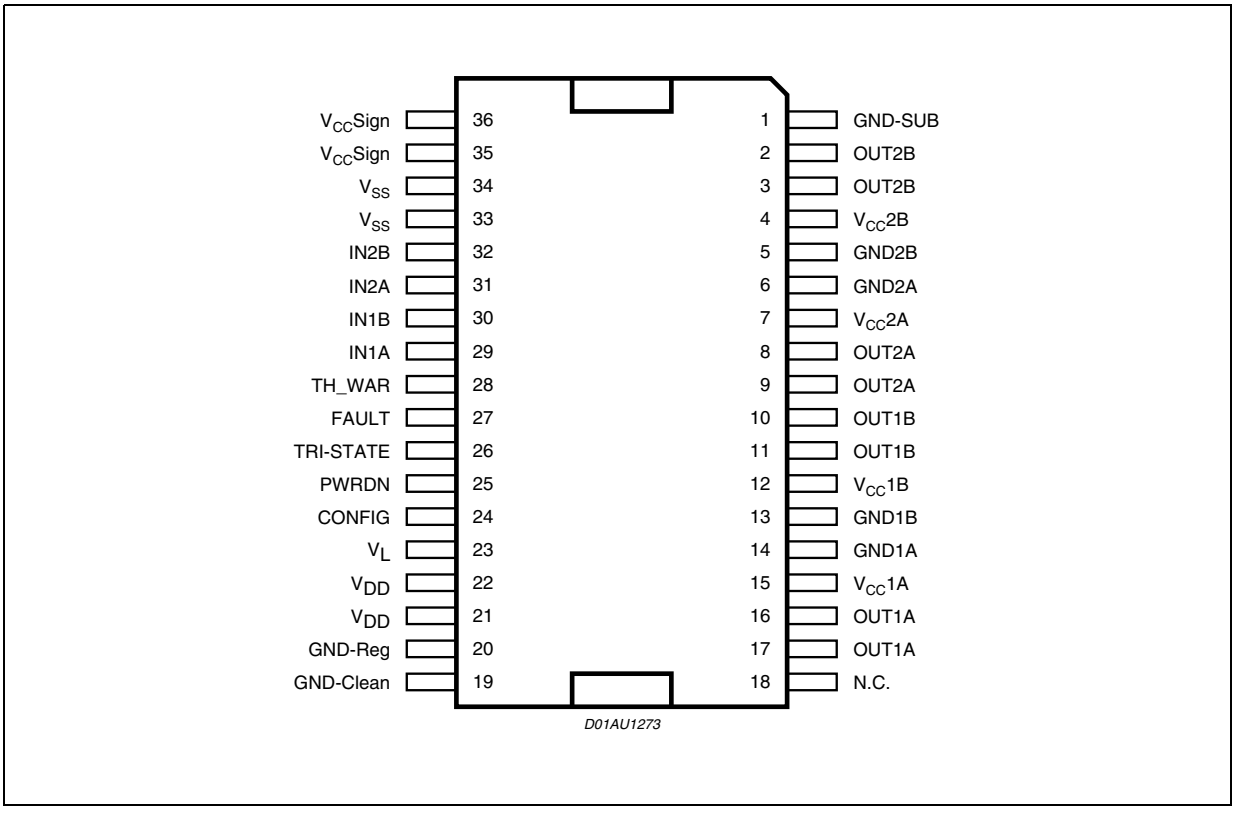


Table 4. THERMAL DATA

Symbol	Description	Value	Unit
$R_{th\ j\text{-}case}$	Thermal Resistance Junction-case	max 1.5	°C/W

Table 5. ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Pin 4,7,12,15)	40	V
V_{max}	Maximum Voltage on pins 23 to 32	5.5	V
P_{tot}	Power Dissipation (T_{case} = 70°C)	50	W
T_{op}	Operating Temperature Range	-40 to 90	°C
T_{stg}, T_j	Storage and Junction Temperature	-40 to 150	°C

Table 6. ELECTRICAL CHARACTERISTCS (V_L = 3.3V; V_{CC} = 30V; T_{amb} = 25°C ; f_{sw} =384 unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
R_{dsON}	Power Pchannel/Nchannel MOSFET RdsON	Id=1A		200	270	mΩ
I_{dss}	Power Pchannel/Nchannel leakage Idss	V_{CC} =35V			50	µA
g_N	Power Pchannel RdsON Matching	Id=1A	95			%
g_P	Power Nchannel RdsON Matching	Id=1A	95			%
Dt_s	Low current Dead Time (static)	see test circuit no.1; see fig. 4		10	20	ns
Dt_d	High current Dead Time (dinamic)	L=22µH; C = 470nF; R_L = 8 Ω Id=3.5A; see fig. 3			50	ns
$t_{d\ ON}$	Turn-on delay time	Resistive load			100	ns
$t_{d\ OFF}$	Turn-off delay time	Resistive load			100	ns
t_r	Rise time	Resistive load; as fig.4			25	ns
t_f	Fall time	Resistive load; as fig. 4			25	ns
V_{CC}	Supply voltage operating voltage		10		36	V
$V_{IN\text{-}High}$	High level input voltage				V_L/2 +300mV	V
$V_{IN\text{-}Low}$	Low level input voltage		V_L/2 - 300mV			V
$I_{IN\text{-}High}$	High level Input current	Pin Voltage = V_L		1		µA
$I_{IN\text{-}Low}$	Low level input current	Pin Voltage = 0.3V		1		µA
$I_{PWRDN\text{-}H}$	High level PWRDN pin input current	V_L = 3.3V		35		µA
V_L	Low logical state voltage VL (pin PWRDN, TRISTATE) (note 1)	V_L = 3.3V	0.8			V

Table 6. ELECTRICAL CHARACTERISTCS (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_H	High logical state voltage VH (pin PWRDN, TRISTATE) (note 1)	V_L = 3.3V			1.7	V
$I_{VCC-PWRDN}$	Supply CURRENT from Vcc in Power Down	PWRDN = 0			3	mA
I_{FAULT}	Output Current pins FAULT -TH-WARN when FAULT CONDITIONS	Vpin = 3.3V		1		mA
$I_{VCC-hiz}$	Supply Current from Vcc in Tri-state	V_{CC} = 30V; Tri-state = 0		22		mA
I_{VCC}	Supply Current from Vcc in operation both channel switching)	V_{CC} =30V; Input Pulse width = 50% Duty; Switching Frequency = 384KHz; No LC filters;		50		mA
I_{VCC-q}	Isc (short circuit current limit) (note 2)		4.5	6	9	A
V_{UV}	Undervoltage protection threshold			7		V
t_{pw-min}	Output minimum pulse width	No Load	70		150	ns

Table 7.

Notes: 1. The following table explains the VLow, VHigh variation with V_L

V_L	VLow min	VHigh max	Unit
2.7	0.7	1.5	V
3.3	0.8	1.7	V
5	0.85	1.85	V

Note 2: See relevant Application Note AN1994

Table 8. Logic Truth Table (see fig. 5)

TRI-STATE	INxA	INxB	Q1	Q2	Q3	Q4	OUTPUT MODE
0	x	x	OFF	OFF	OFF	OFF	Hi-Z
1	0	0	OFF	OFF	ON	ON	DUMP
1	0	1	OFF	ON	ON	OFF	NEGATIVE
1	1	0	ON	OFF	OFF	ON	POSITIVE
1	1	1	ON	ON	OFF	OFF	Not used

Figure 4. Test Circuit.

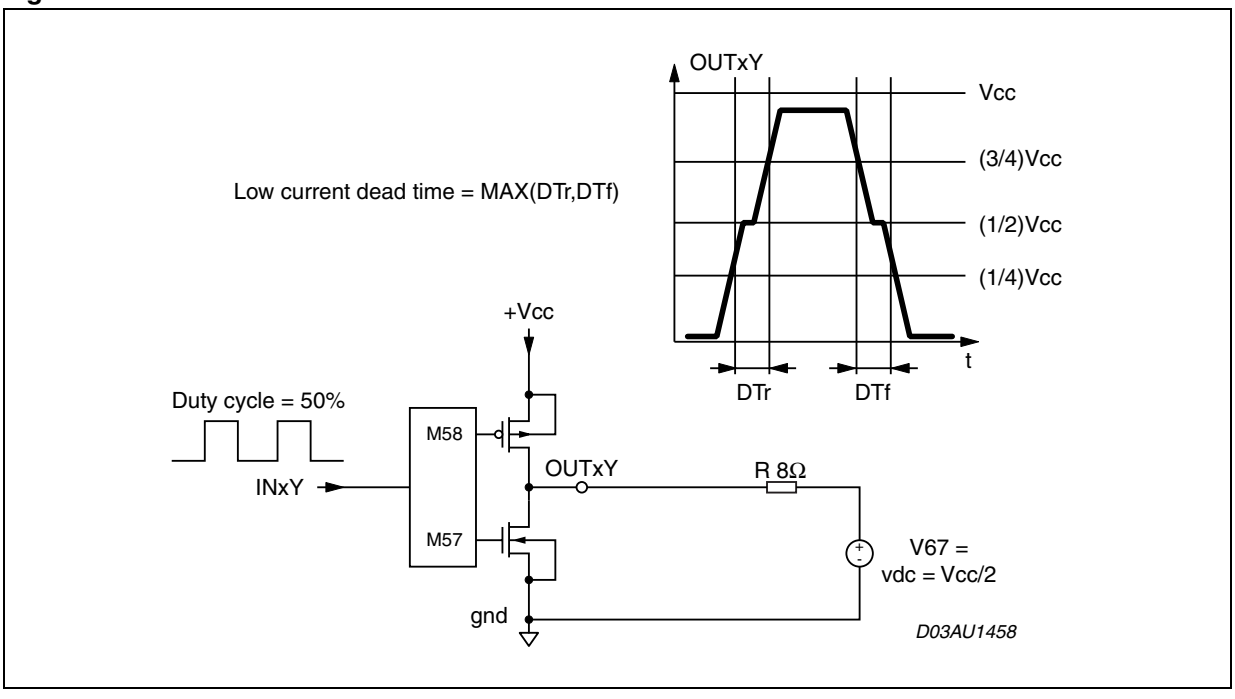


Figure 5.

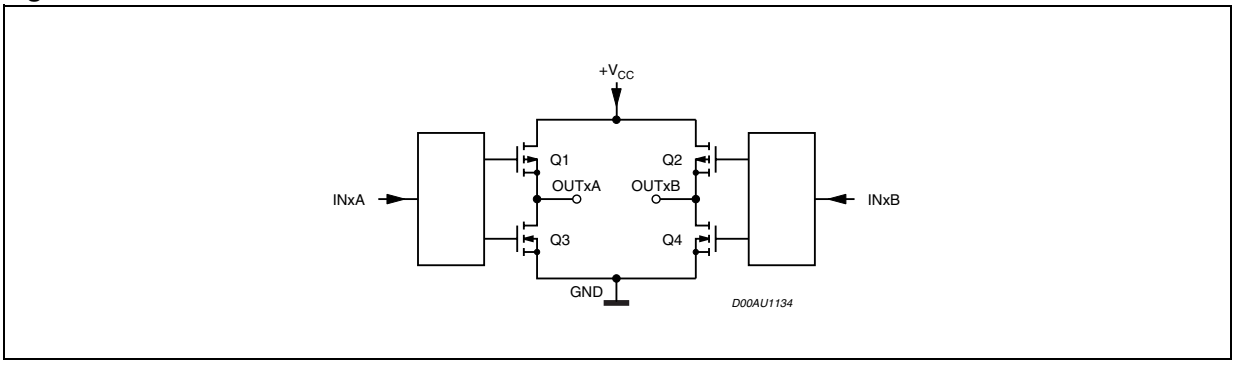


Figure 6.

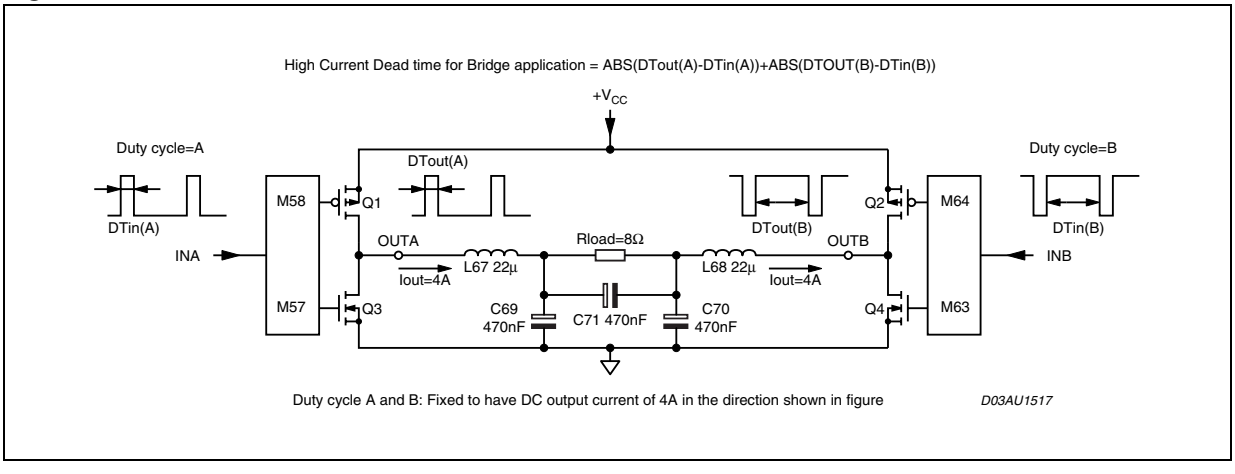


Figure 7. Typical Single BTL Configuration

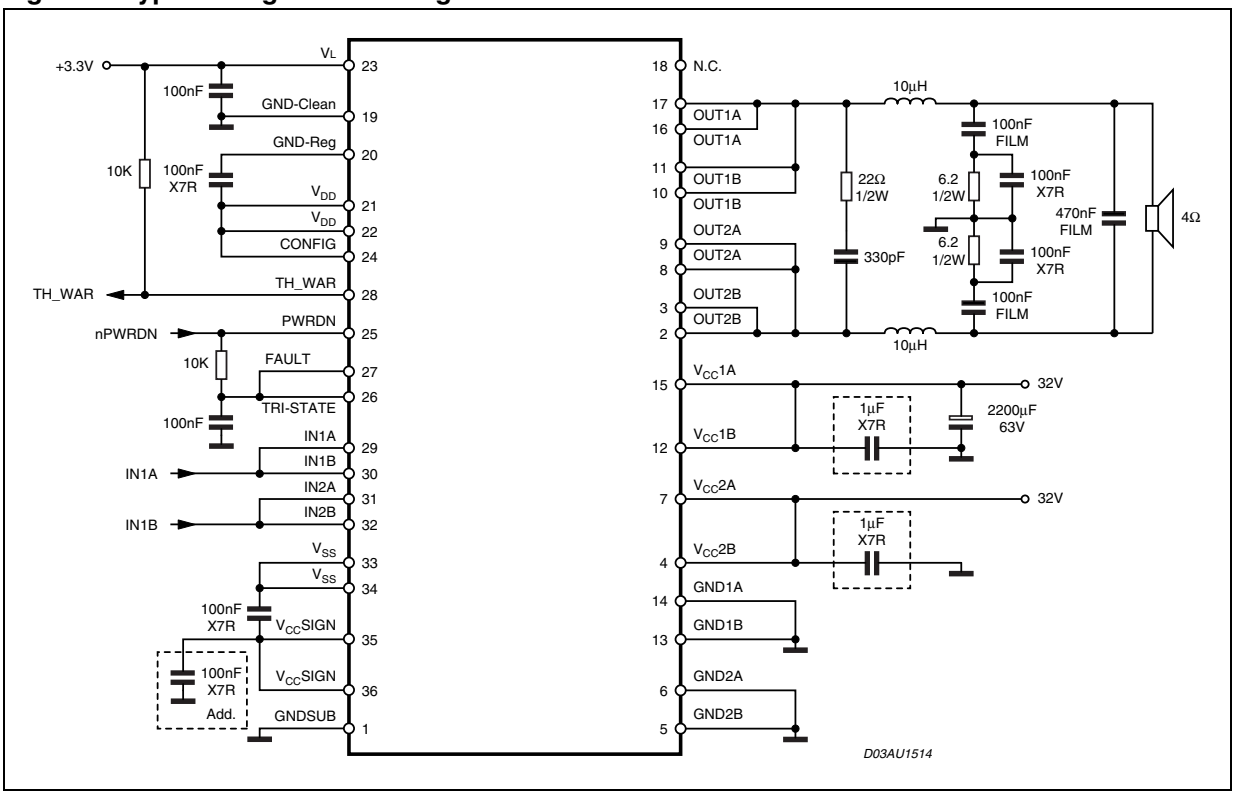
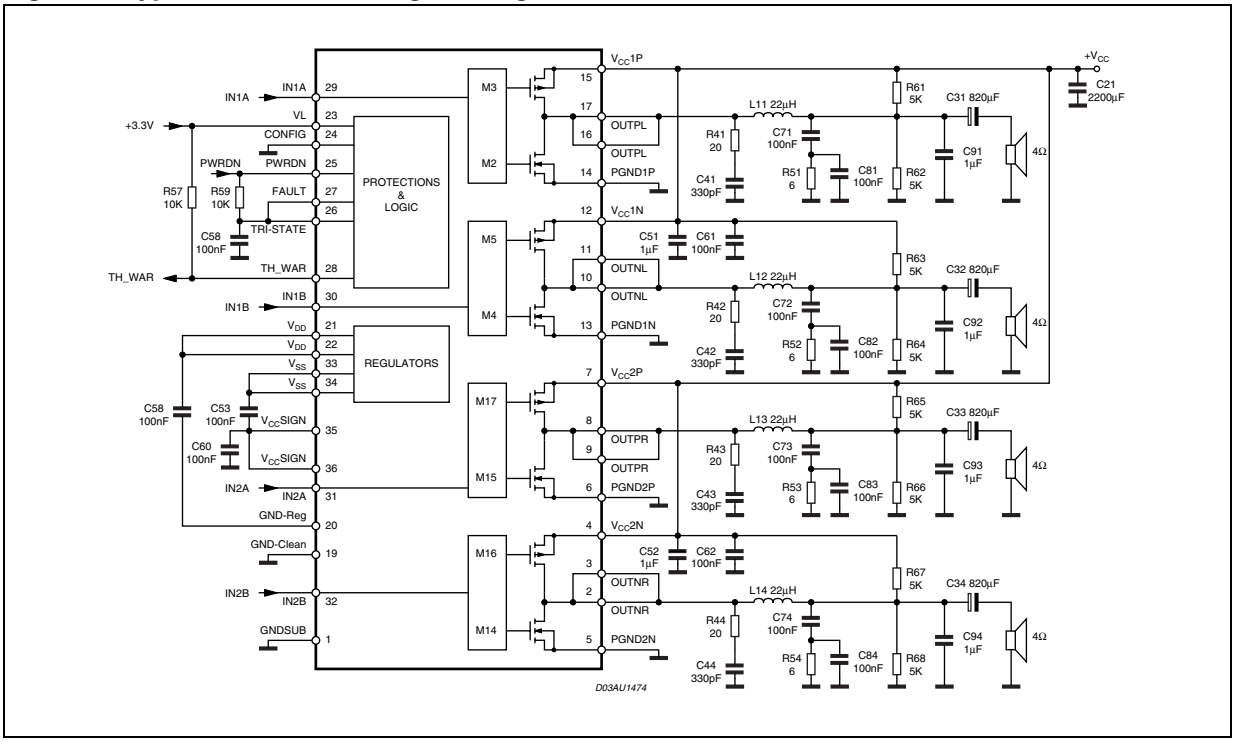


Figure 8. Typical Quad Half Bridge Configuration



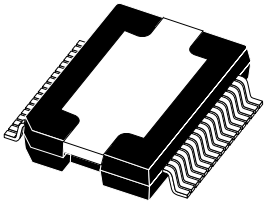
For more information refer to the application notes AN1456 and AN1661

Figure 9. Power SO36 (SLUG UP) Mechanical Data & Package Dimensions

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	3.25		3.43	0.128		0.135
A2	3.1		3.2	0.122		0.126
A4	0.8		1	0.031		0.039
A5		0.2			0.008	
a1	0.030		-0.040	0.0011		-0.0015
b	0.22		0.38	0.008		0.015
c	0.23		0.32	0.009		0.012
D	15.8		16	0.622		0.630
D1	9.4		9.8	0.37		0.38
D2		1			0.039	
E	13.9		14.5	0.547		0.57
E1	10.9		11.1	0.429		0.437
E2			2.9			0.114
E3	5.8		6.2	0.228		0.244
E4	2.9		3.2	0.114		1.259
e		0.65			0.026	
e3		11.05			0.435	
G	0		0.075	0		0.003
H	15.5		15.9	0.61		0.625
h			1.1			0.043
L	0.8		1.1	0.031		0.043
N			10°			10°
s			8°			8°

(1) “D and E1” do not include mold flash or protusions.
Mold flash or protusions shall not exceed 0.15mm (0.006”)
(2) No intrusion allowed inwards the leads.

OUTLINE AND MECHANICAL DATA



PowerSO36 (SLUG UP)

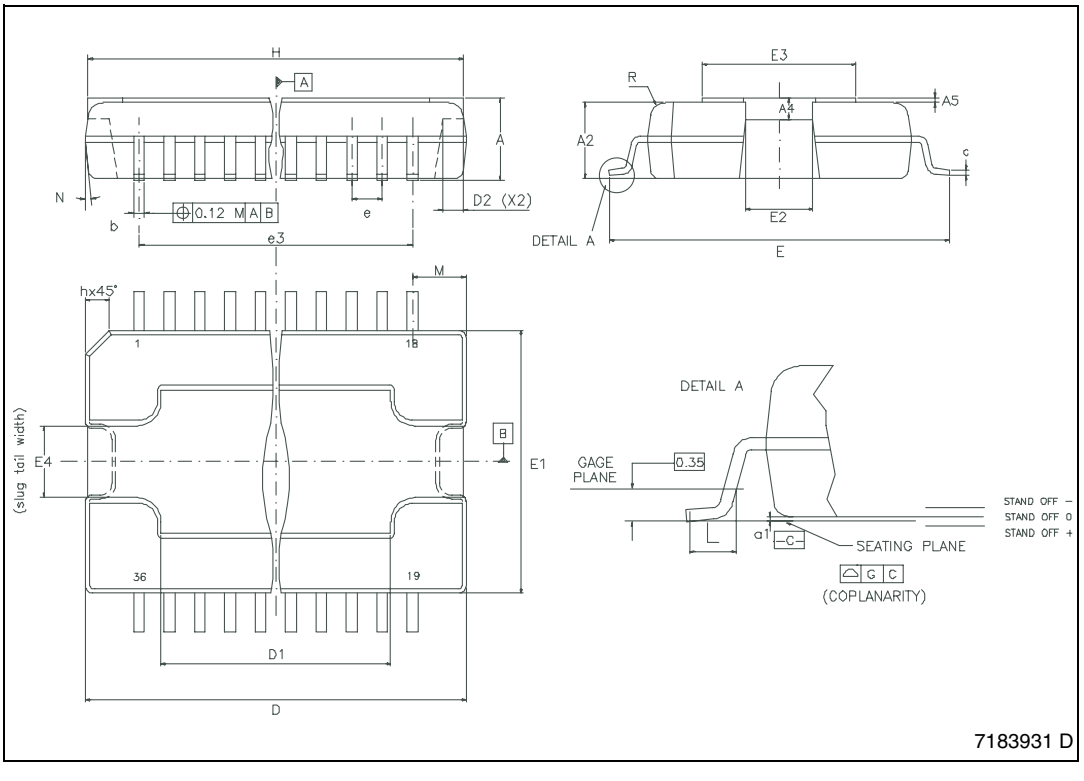


Table 9. Revision History

Date	Revision	Description of Changes
September 1994	1	First Issue
June 2004	2	Note 2: See relevant Application Note AN1994
November 2004	3	Changed Vcc from 9 min to 10 min
February 2006	4	Changed T_{op} value on Table 5.

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